Docket No.

274431US0PCT

T AND TRADEMARK OFFICE IN THE UNIT

IN RE APPLICATION OF: Yukio KITAIKE, et a

SERIAL NO: 10/541,729 MAIL STOP PCT

FILED:

July 11, 2005 FYAMINER-

MULTILAYER STRUCTURE POLYMER AND RESIN COMPOSITION TOGETHER WITH ACRYLIC RESIN FOR: FILM MATERIAL, ACRYLIC RESIN LAMINATE FILM, PHOTOCURABLE ACRYLIC RESIN FILM OR

SHEET, LAMINATE FILM OR SHEET AND LAMINATE MOLDING OBTAINED BY LAMINATING THEREOF

INFORMATION DISCLOSURE STATEMENT UNDER 37 CFR 1.97

COMMISSIONER FOR PATENTS ALEXANDRIA, VIRGINIA 22313

SIR:

Applicant(s) wish to disclose the following information.

#### REFERENCES

The applicant(s) wish to make of record the references listed on the attached form PTO-1449. Copies of the listed references are attached, where required, as are either statements of relevancy or any readily available English translations of pertinent portions of any non-English language references.

A check or credit card payment form is attached in the amount required under 37 CFR §1.17(p).

## RELATED CASES

- ☐ Attached is a list of applicant's pending application(s), published application(s) or issued patent(s) which may be related to the present application. In accordance with the waiver of 37 CFR 1.98 dated September 21, 2004, copies of the cited pending applications are not provided. Cited published and/or issued patents, if any, are listed on the attached PTO form 1449.
- A check or credit card payment form is attached in the amount required under 37 CFR §1.17(p).

## CERTIFICATION

- ☐ Each item of information contained in this information disclosure statement was first cited in any communication from a foreign patent office in a counterpart foreign application not more than three months prior to the filing of this statement.
- ☐ No item of information contained in this information disclosure statement was cited in a communication from a foreign patent office in a counterpart foreign application or, to the knowledge of the undersigned, having made reasonable inquiry, was known to any individual designated in 37 CFR §1.56(c) more than three months prior to the filing of this statement.

### DEPOSIT ACCOUNT

Please charge any additional fees for the papers being filed herewith and for which no check or credit card payment is enclosed herewith, or credit any overpayment to deposit account number 15-0030. A duplicate copy of this sheet is enclosed.

Respectfully submitted,

OBLON, SPIVAK, McCLELLAND, MAIER & NEUSTADT, P.C.

Norman F. Oblon

Sprinder Sachar

Registration No. 34,423

Customer Number

Tel. (703) 413-3000 Fax. (703) 413-2220 (OSMMN 05/03)

Form PTO 1449 (Modified)		U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE		ATTY DOCKET NO. 274431US0PCT		SERIAL NO. 10/541,729		
LIST OF	REFE	REMODES CITED AND A	PPLICANT	APPLICANT Yukio KITAIKE, et al.				
LIST OF REFERENCES CITED & APPLICANT		July 11, 2005		GROUP				
	,	13	/	U.S. PATENT DOCUMENTS				
EXAMINER INITIAL		NOMBER .	DATE	NAME	CLASS	SUB CLASS	FILING DATE IF APPROPRIATE	
	AA							
	AB							
	AC							
	AD							
	AE							
	AE							
	AG							
	AH				_			
	AI AJ							
	AK		-		_			
	AL		+		-			
	AM		-		_			
	AN		1		_			
			FO	REIGN PATENT DOCUMENTS				
		DOCUMENT NUMBER	DATE	COUNTRY	YE		TRANSLATION S NO	
/DSN/	AO	2000-317976	11/21/00	JP (with English abstract)			NO	
	AP							
	AO		-					
	AR							
	AS							
	AU		-					
	AV		-					
		OTHER R	EEEDENCES	Including Author, Title, Date, Perti	nont Bogos, o	to )		
	AW	OTHERN	EFERENCES	including Author, True, Date, Perti	nent rages, e			
	_							
	AX					-		
	AY							
	AZ			Additional References sheet(s) attached			rences sheet(s) attached	
Examiner /D. S. Nakarani/					Date Cor	nsidered	12/16/2008	

U.S. PCT Application Street Filed: July 11, 2005

Yukio KITAIKE, et al. Docket No. 274431 US

# STATEMENT OF RELEVANCY

- 1) References have been cited in the International Search Report. A copy of these references is being submitted herewith.
- 2) Reference AO has been cited in the corresponding Japanese Office Action. A partial translation of the Office Action and a copy of the reference is being submitted herewith.
- 3) References are discussed in the specification. A copy of these references is being submitted herewith.
- 4) References are additional prior art known to Applicant. A copy of these references is being submitted herewith.